1-2355627-1 ✓ ACTIVE

TE Internal #: 1-2355627-1

Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount, Vertical Module Orientation, .85 mm [.033 in]

Centerline, DIMM Sockets

View on TE.com >



Connectors > Socket Connectors > Memory Sockets > DIMM Sockets



DRAM Type: Double Data Rate (DDR) 5

Connector System: Board-to-Component

Number of Positions: 288

Termination Method to PCB: Surface Mount

Module Orientation: Vertical

Features

Electrical Characteristics

DRAM Voltage	1.1 V
Operation/Application	
Circuit Application	High Speed Data
Industry Standards	
UL Flammability Rating	UL 94V-0
Mechanical Attachment	
Connector Mounting Type	Board Mount
PCB Mount Retention	With
Mount Angle	Vertical
PCB Mount Retention Type	Tab
Mating Alignment Type	1 Key
Mating Alignment	With
PCB Mount Alignment Type	None

Contact Features



Contact Underplating Material	Nickel
Socket Style	DIMM
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
PCB Contact Termination Area Plating Material Thickness	3 μm[120 μin]
Contact Mating Area Plating Material	Gold
Memory Socket Type	Memory Card
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
Contact Current Rating (Max)	1.5 A
Packaging Features	
Packaging Quantity	640
Packaging Method	Box & Tray
Body Features	
Latch Color	Natural
Latch Material	High Temperature Nylon
PCB Retention Feature Material	Stainless Steel
Connector Profile	Standard
Ejector Material Color	Natural
Module Key Type	DRAM
Ejector Location	Both Ends
Ejector Material	High Temperature Nylon
Ejector Type	Rotary
Dimensions	
Profile Height from PCB	21.3 mm[.083 in]
Row-to-Row Spacing	3 mm[.118 in]
Housing Features	
Housing Color	Black
Housing Material	High Temperature Nylon
Centerline (Pitch)	.85 mm[.033 in]
Termination Features	
Insertion Style	Direct Insert
Termination Post & Tail Length	.89 mm[.035 in]



Termination Method to PCB	Surface Mount
Configuration Features	
Number of Keys	1
Number of Bays	2
Number of Rows	2
Number of Positions	288
Module Orientation	Vertical
Product Type Features	
Connector & Contact Terminates To	Printed Circuit Board
Connector & Contact Terminates To DRAM Type	Printed Circuit Board Double Data Rate (DDR) 5
DRAM Type	Double Data Rate (DDR) 5
DRAM Type Connector System	Double Data Rate (DDR) 5
DRAM Type Connector System Usage Conditions	Double Data Rate (DDR) 5 Board-to-Component
DRAM Type Connector System Usage Conditions Operating Temperature Range	Double Data Rate (DDR) 5 Board-to-Component

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these



limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



LGA4189-5 SOCKET P5 KIT FOR ODM (30U AU)



Customers Also Bought



CAGE ASSY, QSFP28 1X1, SPRING, HS



1X2 CAGE ASSY BHND BZL QSFP28



TE Part #2-5/6/004-2 MICTOR RECEPT ASSY, 38 POS.



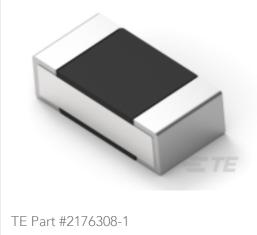
TE Part #5/50069-1 Mini DIN, 4 pos, R/A, Shield



TE Part #2-2362375-4 PCIE GEN4, 164POS ,30u" ,DIP ,2.3 mm TAIL



TE Part #9-2176307-5 RP 1E 0.1W 118K 0.1% 25PPM 5K RL



RP 1E 0.1W 133K 0.1% 25PPM 5K RL







Documents



Product Drawings

DDR5 DIMM BLACK HSG AND NATRUAL LATCH

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-2355627-1_A.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_1-2355627-1_A.3d_igs.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2355627-1_A.2d_dxf.zip

English

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Product Specifications

Application Specification

English